

**RoHS Compliant**

1213-SERIES SFF-8639 RECEPTACLE CONNECTOR

REV	DATE	DESCRIPTION	ECN NO.	NAME
A	15.02.26	PROPOSAL		HSIEN
B	15.12.14	NEW RELEASE		HSIEN

NOTE

1.MATERIAL

HOUSING : HIGE THERMOPLASTIC, UL94V-0,BLACK.  
 CAP : HIGE THERMOPLASTIC, UL94V-0,BLACK.  
 TERMINAL : COPPER ALLOY,  
 BOARD LOCK : COPPER ALLOY,

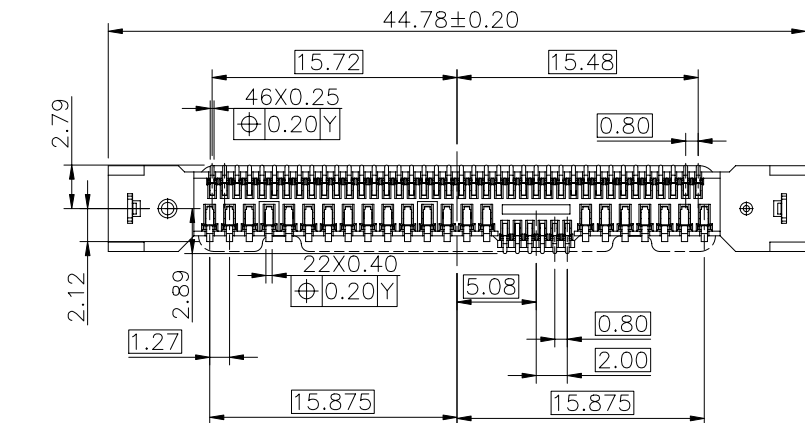
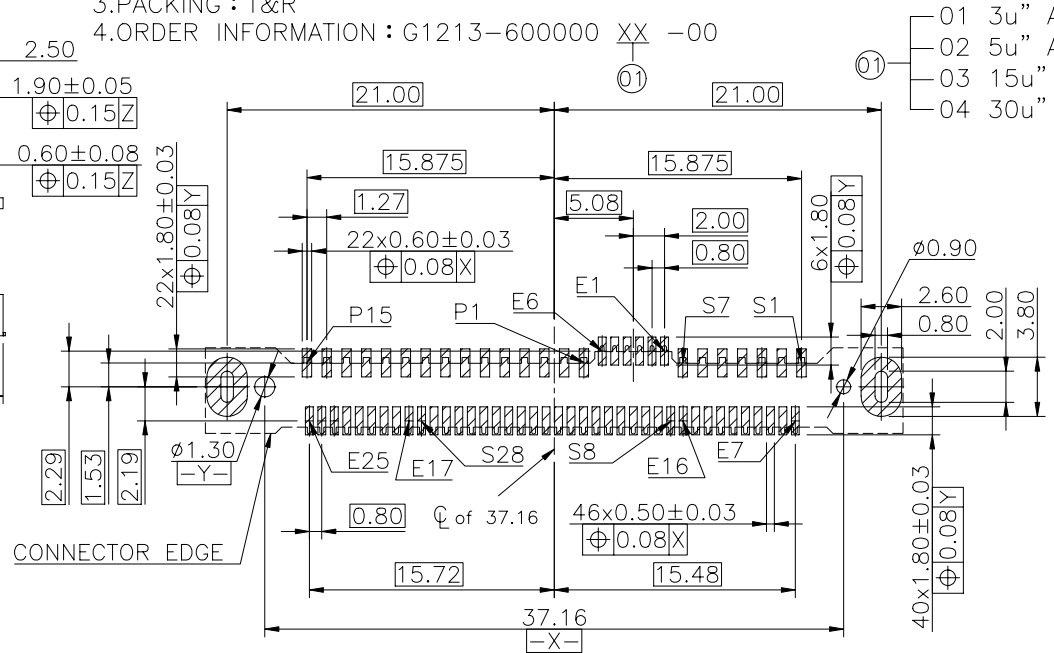
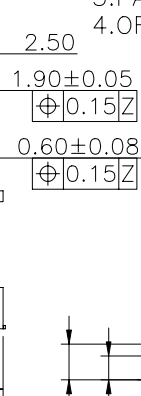
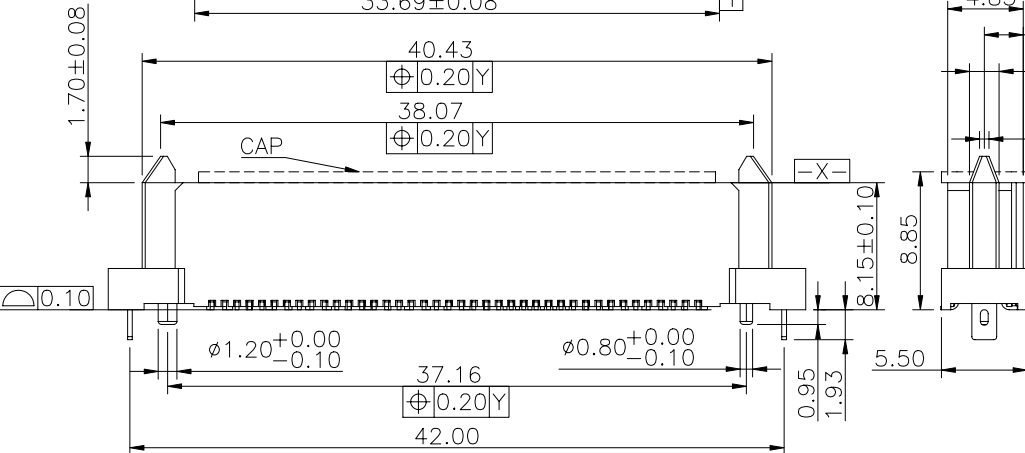
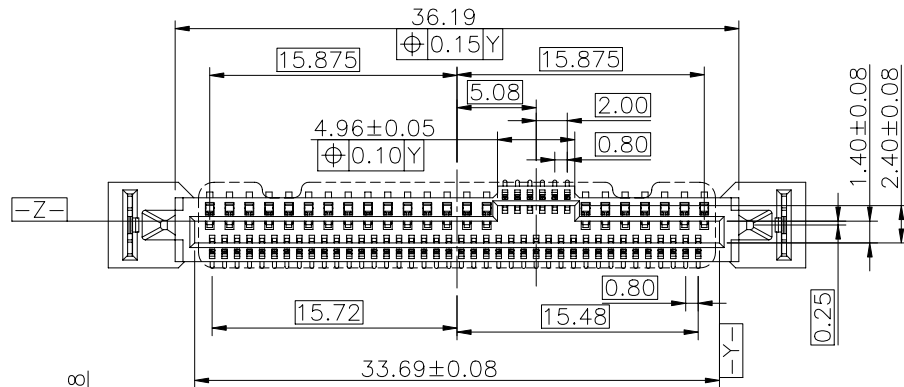
2.PLATING

TERMINAL : SELECTIVE Au ON CONTACT AREA,(SEE ORDER INFORMATION)  
 100u" MIN. Sn PLATED ON SOLDER TAIL AREA,  
 BOTH OVER 50u" MIN. Ni UNDERPLATED OVERALL.  
 BOARD LOCK : 100u" MIN.Sn PLATED ON SOLDER TAIL AREA,  
 BOTH OVER 50u" MIN. Ni UNDERPLATED OVERALL.

3.PACKING : T&R

4.ORDER INFORMATION : G1213-600000 XX -00

- 01 3u" Au
- 02 5u" Au
- 03 15u" Au
- 04 30u" Au



GENERAL TOLERANCE		WIESON TECHNOLOGIES CO., LTD		PART NO.:	
X.X	±0.20	DRAWN BY HSIEN		G1213-600000XX-00	
X.XX	±0.15			DRAWING NO. G1213-600000XX-00	
X.X*	±3°			DRAWING SIZE 2 : 1 A4	
		CHECKED BY FRED LEE		UNIT mm	
		APPROVED BY FRED LEE		PAGE 1 OF 1	
		SORTING NO. WST			